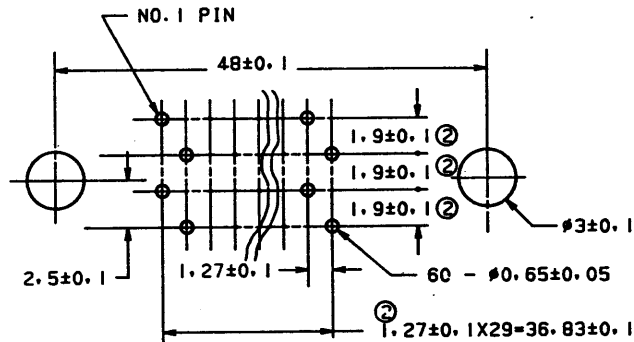


PRODUCT NO	HOUSING COLOR	Au PLATING THK.
69740-001	WHITE	0.1μm MIN
69740-002	BLACK	0.1μm MIN
69740-101	WHITE	0.76μm MIN
69740-102	BLACK	0.76μm MIN

REVISIONS			
REV	DESCRIPTION	BY	DATE
	SEE 1 OF 2		



RECOMMENDED MOUNTING DIMENSION (TOP VIEW)

NOTES:

- ①. MATERIAL AND FINISH:
PIN
 MATERIAL - PHOS. BRO.
 FINISH - ALL OVER Ni UNDERPLATING 0.5μm THK MIN.
 CONTACT AREA - Au PLATING (THK. SEE TABLE),
 OVER Pd-Ni PLATING 0.5μm THK MIN.
SOLDER TAIL - S.p.(9/1) PLATING 3.8μm THK MIN.
CAP HOUSING (R/A)
 MATERIAL - 66 NYLON GLASS 25% FILLED, UL94V-0.
- ②. TO BE NONCUMULATIVE TOLERANCE.
- ③. PIN RETENTION FORCE 0.5Kg/PIN MIN.
- ④. TO BE SYMMETRY WITHIN ±0.1 ABOUT DATUM B.
- ⑤. TO BE SYMMETRY WITHIN ±0.1 ABOUT DATUM C.
- ⑥. TO BE SYMMETRY WITHIN ±0.3 ABOUT DATUM D.

SHEET INDEX										ISSUE		SH NO		1		CUSTOMER COPY		CODE IDENT		22526		DuPont Electronics		DUPONT							
LEVELS				DO NOT SCALE DRAWING				TOLERANCE UNLESS OTHERWISE NOTED				MM/INCH ±0.3		MATERIAL		DR		DATE		M. KITAMURA		09/21/87		TITLE		IC CARD CONNECTOR 60 POS. CAP ASS'Y (R/A)					
				THIRD ANGLE PROJECTION				LINEAR				SEE NOTE ①		CHK		10/2/87															
TABULATION SHEETS REQUIRED				YES		NO		ANGLES				SEE NOTE ①		ENGR		10/2/87		APPD		10/5/87		SCALE		SIZE		DWG NO		CAD		CUST	
								±2° ±5°						H. Saito				5-1		C		69740		SHEET 2 OF 2							

PDM Rev. Released